CL-442 Product Family Specification

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USING THIS DOCUMENT

The specifications contained herein represent all possible configurations for this product family. The actual configurations available on each module may be a subset of this specification. Please refer to the module-specific datasheet for the connector pinout and configurations that are available.

USER LIABILITY

The OEM of a machine or vehicle in which HED® electronic controls are installed is fully responsible for all consequences that might occur. HED®, and any authorized distributor, has no responsibility for any consequences, direct or indirect, caused by failures or malfunctions. Failure or improper selection or improper use of HED® products can cause death, personal injury and property damage.

The OEM must analyze all aspects of their application and review the information concerning product or system in the current product documentation. Due to the variety of operating conditions and applications for these products or systems, the user, through its own analysis and testing, is solely responsible for making the final selection of the products and systems and assuring that all performance, safety and warning requirements of the application are met.

The products described herein, including without limitation, product features, specifications, designs, availability and pricing, are subject to change by HED® at any time without notice.

INPUT STB or STG (PINS A01-A02, B10-B12) INPUT STB or STG or VTD (PINS A03-A04, B05-B09) INPUT STB or STG or VTD or FREQ/PWM/ENCODER (PINS A05-A08)

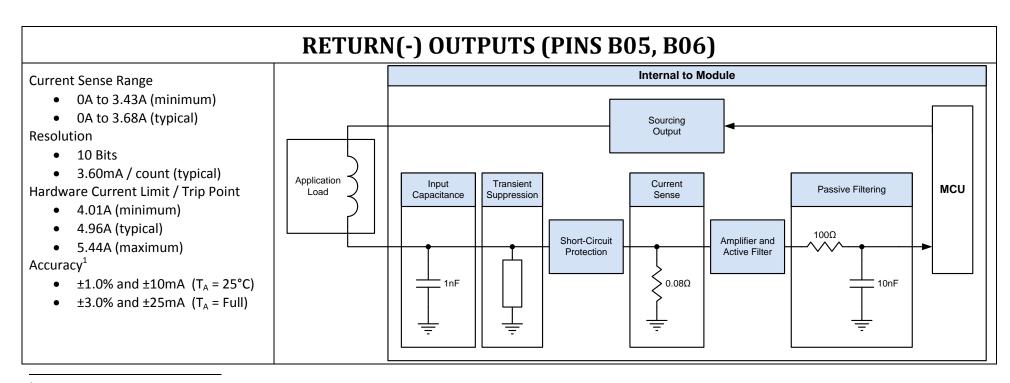
Switch-to-Battery (STB) Input Resistance Internal to Module • 3.21KΩ (typical) Input Current Application Switch Input Pull-down Filtering Capacitance Resistance 2.5mA at 8V (typ) • 11.0mA at 32V (typ) BAT+ 10ΚΩ Positive Going Threshold 10ΚΩ MCU Voltage Clamp • > 6.5V **Negative Going Threshold** 3.83ΚΩ 10ΚΩ 68nF 0.22µF • < 3.5V Parallel Resistance • 3KΩ at 8V (minimum) • 22KΩ at 32V (minimum) Series Resistance • 220Ω (maximum) **Switch-to-Ground (STG)** Internal to Module Pull-up Resistance Pull-up • 1.2KΩ (typical) Resistance **Input Current** • 3.5mA at 0V (typical) **Application Switch** Input Filtering Positive Going Threshold Capacitance >3.25V 1.2ΚΩ **Negative Going Threshold** 5.76KΩ 10ΚΩ MCU Voltage Clamp < 1.75V NOTE: Parallel Resistance Resistor is 68nF 0.22µF pulled up to • 3KΩ at 0V (minimum) 5V through Series Resistance a rectifier diode. 220Ω (maximum)

INPUT STB or STG (PINS A01-A02, B10-B12) INPUT STB or STG or VTD (PINS A03-A04, B05-B09) INPUT STB or STG or VTD or FREQ/PWM/ENCODER (PINS A05-A08)

Voltage-to-Digital (VTD) Internal to Module (0 - 5.64VDC)Input Voltage Range Input **Application Sensor** Voltage Scaling Filtering Capacitance 0V to 5.37V (minimum) 0V to 5.64V (typical) Input Resistance 10ΚΩ 100Ω Voltage Clamp MCU 57.5KΩ (typical) Resolution 68nF 47.5ΚΩ 0.22µF 10 Bits • 5.51mV / count (typical) Accuracv¹ • $\pm 1.0\%$ and ± 11 mV ($T_A = 25$ °C) • $\pm 2.5\%$ and ± 71 mV (T_A = Full) Frequency / PWM / Encoder Internal to Module Pull-up Resistance Pull-up 28KΩ (typical) Resistance Positive Going Threshold Input Filtering Schmitt Trigger • > 3.5V Capacitance Application Sensor **Negative Going Threshold** • < 1.5V 28ΚΩ Frequency Range 20ΚΩ Voltage MCU • 10KHz (maximum)² Clamp Resolution NOTE: 100pF 100pF Resistor is • < 5 Hz pulled up to 5V through a Accuracy rectifier diode • $\pm 2.0\%$ (T_A = full range)

¹ VTD accuracy is estimated using datasheet maximums and a weighted average of worst-case and root-sum-square (RSS) methods. It is considered as a percentage of the input voltage combined with an additional offset.

² Frequency range maximum assumes square wave, open-drain, sinking sensor at 50% duty cycle. Actual maximum may vary based on application sensor capacitance.



¹ Return(-) Output accuracy is estimated using datasheet maximums and a weighted average of worst-case and root-sum-square (RSS) methods. It is considered as a percentage of the return current combined with an additional offset. These values assume factory calibration.

5VDC SENSOR SUPPLY (PIN B05, B08) AND SENSOR GROUND (PIN B06, B09)

5VDC Sensor Supply Mode

Voltage Range

• 5V ± 5%

Current Rating

500mA

Current Limit

- 600mA (minimum)
- 940mA (typical)

Analog Monitoring Circuit

Resolution

- 10 Bits
- 5.51mV / count (typical)

Accuracy

 See Section Input – VTD Mode (0-5.64V Range)

5VDC Sensor Ground Mode

Current Rating

• 500mA

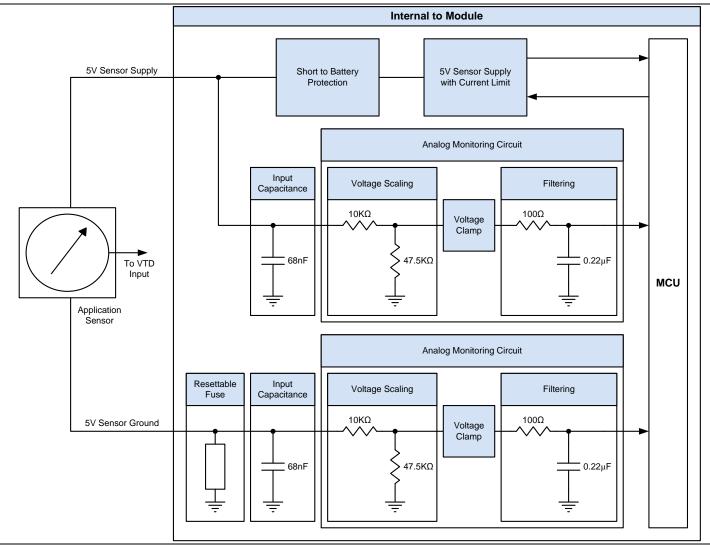
Analog Monitoring Circuit

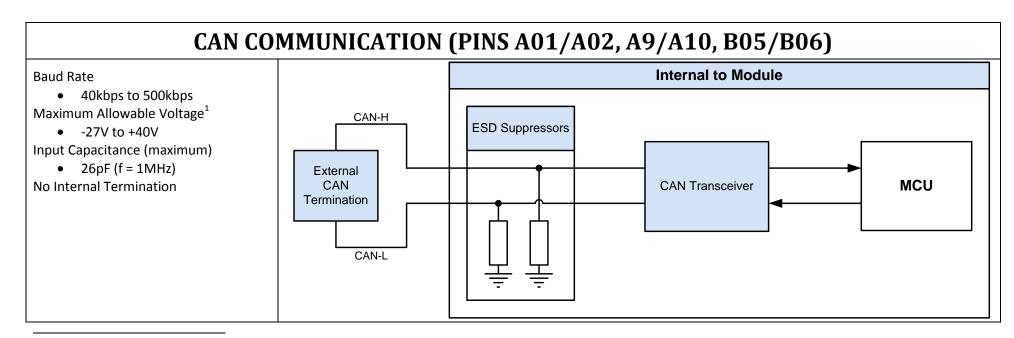
Resolution

- 10 Bits
- 5.51mV / count (typical)

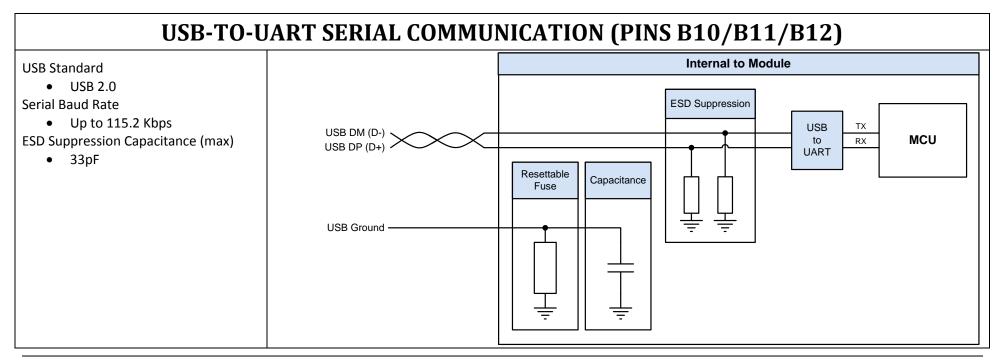
Accuracy

 See Section Input – VTD Mode (0-5.65V Range)





¹ Maximum allowable voltage defines the voltage extremes that the transceiver can tolerate. Exposure to these voltages for extended periods may affect device reliability.



OUTPUT DOUT(+)/PWM(+)/ECC(+) (PINS B01-B04)

Individual Output Current¹

- Digital Mode = 3.0A (maximum)
- PWM Mode = 3.0A (maximum)

Grouped Output Current^{2,3}

- Digital Mode = 2.5A (maximum)
- PWM Mode = 2.0A (maximum)

PWM Frequency⁴

- < 300 Hz (typical)
- < 1 KHz (maximum)

Output Diagnostics

- Short to Battery
- Short to Ground
- Overcurrent
- Open Circuit⁵

Current Sense Range

- Up to 3.6A (minimum)
- Up to 4.5A (typical)

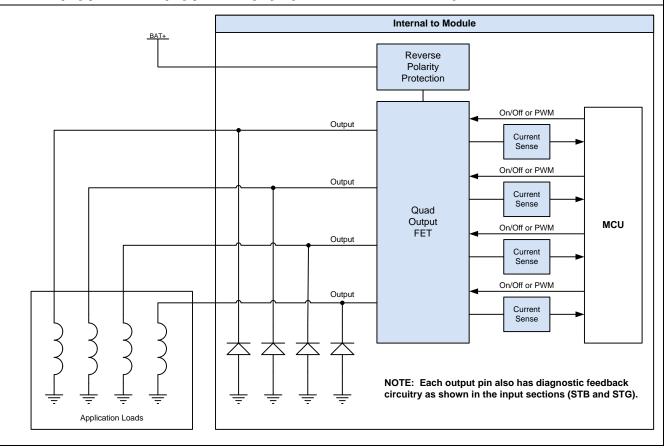
Current Sense Resolution

- 10 bits
- 4.4mA / count (typical)

Current Sense Accuracy (typical)

• ±50mA at 2A, T_A = 25°C

Internal Flyback Diodes



¹ Individual Output Current specifies the maximum current for an individual output channel. Additional restrictions regarding total output current, number of active channels, etc. will apply and are specified in the Grouped Output Current parameter. PWM outputs assume 250Hz frequency.

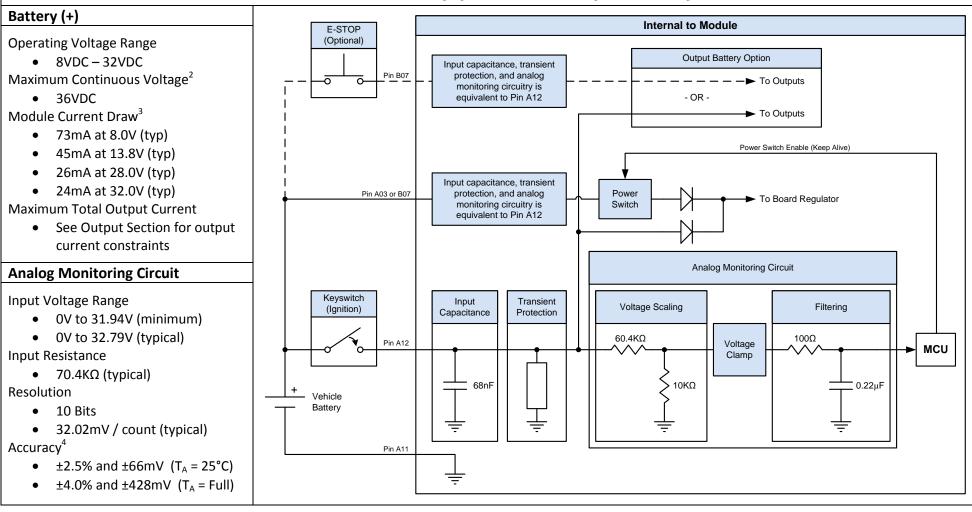
² Output current maximums assume all four channels are active simultaneously and the module is at maximum ambient temperature. PWM outputs assume 250Hz frequency. Output current may be increased per channel (up to the individual output current maximum) if not all channels are active simultaneously or other channels are at a reduced load current. Please contact HED® for further information.

³ Maximum total output current for Pins B01-B04 is 10 Amps.

⁴ The output driver is best suited for PWM frequencies of 300 Hz or less. PWM frequencies of up to 1 KHz are possible, but at reduced output current and duty cycle range.

⁵ Open circuit can be detected when the output is active using current sense feedback for load currents of at least 250mA and duty cycle of 100%. Open circuit can be detected when the output is inactive using the pull-up resistor for loads that are not influenced by the associated pull-up current (see Input STG circuit diagram and parameters).

BATTERY (+) MODULE (PIN A12), UNSWITCHED BATTERY (+) (PIN A03, B07), AND BATTERY (+) OUTPUTS (PIN B07)¹



¹ The block diagram shown represents one possible implementation in the system. Other implementations may be used based on system requirements.

² Exposure to maximum voltages for extended periods may affect device reliability.

³ Module current draw is measured with I/O inactive, no CAN communication, and 5V sensor supply disabled.

⁴ VTD accuracy is estimated using datasheet maximums and a weighted average of worst-case and root-sum-square (RSS) methods. It is considered as a percentage of the input voltage combined with an additional offset.

ADDITIONAL NOTES

IMPORTANT: Module configurations that contain sourcing outputs with internal flyback diodes may continue to operate in the event of a loss of module ground. This event can result in a ground shift to the internal board reference (ground). The ground shift is a result of a remaining current path from internal board reference (ground), through internal flyback diode(s), and terminating through an external load to ground (assuming the load is of relatively low resistance). Depending on system configuration and load resistances, analog input accuracy can be affected, especially if the analog sensor is not referenced to the module sensor ground. Be sure to include this condition when conducting a system-level FMEA.

| REVISION HISTORY | | | |
|------------------|----------|---------|---|
| Revision | Date | EC# | Changes |
| A1 | 12/19/14 | 314-542 | Initial Release. |
| A2 | 7/15/15 | 315-246 | Added switching thresholds to STB and STG inputs. Added note regarding loss of ground event. |
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